

UP0487CG

Silicon N-channel MOSFET

For switching circuits

■ Features

- High-speed switching
- Incorporating a built-in gate protection-diode
- Two elements incorporated into one package (Each transistor is separated)
- SSMini type package, reduction of the mounting area and assembly cost

■ Basic Part Number

- 2SK3937 × 2

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Drain-source surrender voltage	V_{DSS}	20	V
Gate-source surrender voltage	V_{GSS}	± 12	V
Drain current	I_{D}	100	mA
Peak drain current	I_{DP}	200	mA
Total power dissipation	P_{T}	125	mW
Channel temperature	T_{ch}	125	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to $+125$	$^\circ\text{C}$

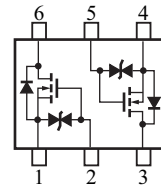
■ Package

- Code
SSMini6-F2
- Pin Name

1: Source (FET1)	4: Source (FET2)
2: Gate (FET1)	5: Gate (FET2)
3: Drain (FET2)	6: Drain (FET1)

■ Marking Symbol: 2V

■ Internal Connection



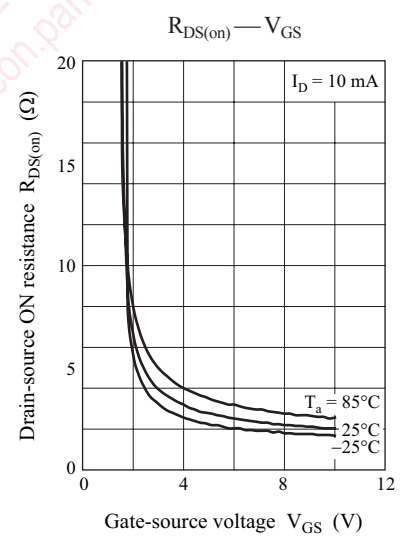
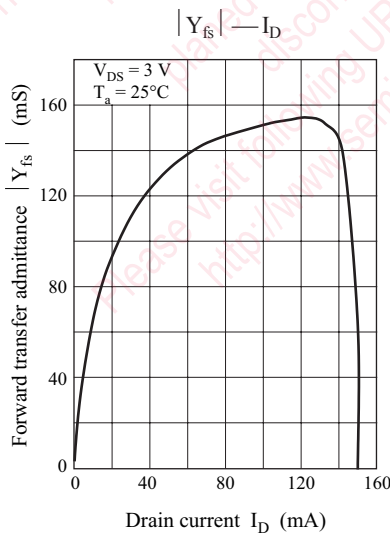
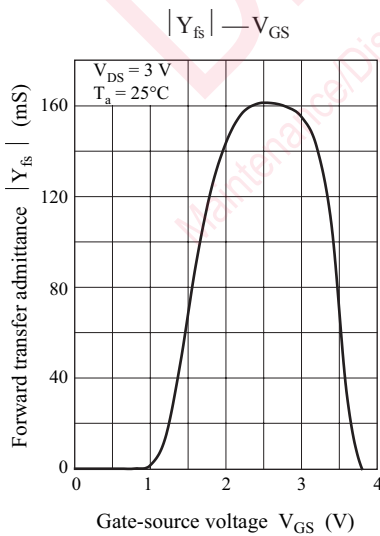
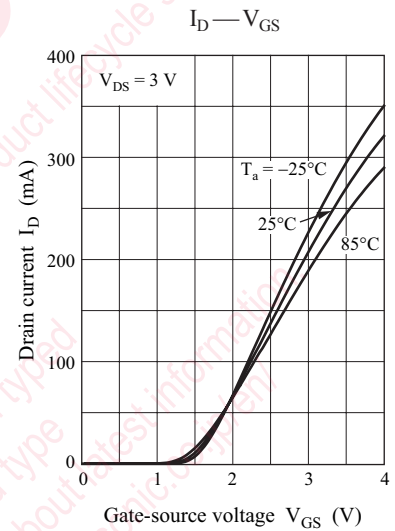
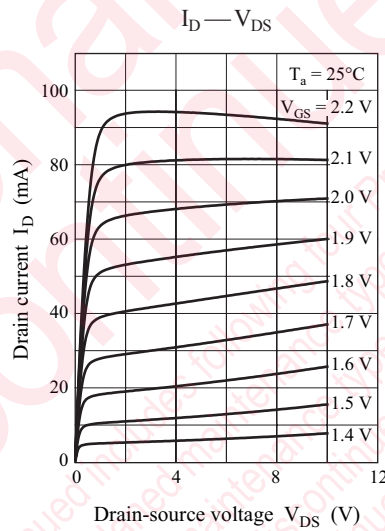
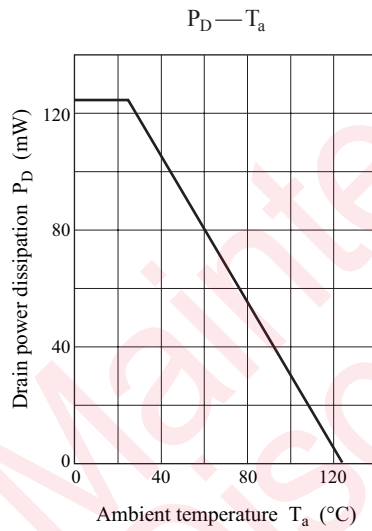
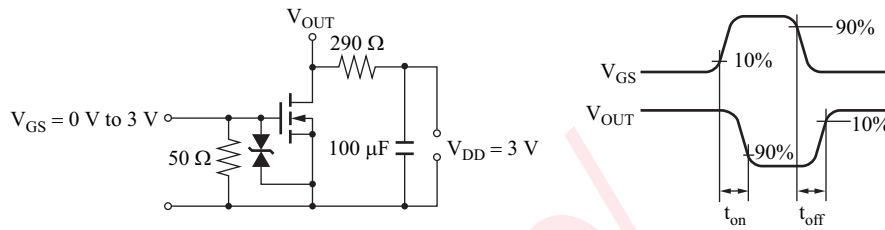
■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Drain-source surrender voltage	V_{DSS}	$I_{\text{D}} = 10 \mu\text{A}$, $V_{\text{GS}} = 0$	20			V
Drain-source cutoff current	I_{DSS}	$V_{\text{DS}} = 10 \text{ V}$, $V_{\text{GS}} = 0$			1.0	μA
Gate-source cutoff current	I_{GSS}	$V_{\text{GS}} = \pm 10 \text{ V}$, $V_{\text{DS}} = 0$			± 10	μA
Gate threshold voltage	V_{TH}	$I_{\text{D}} = 50 \mu\text{A}$, $V_{\text{DS}} = 5.0 \text{ V}$	0.4		1.3	V
Drain-source ON resistance	$R_{\text{DS(on)}}$	$I_{\text{D}} = 1 \text{ mA}$, $V_{\text{GS}} = 1.8 \text{ V}$		6	13	Ω
		$I_{\text{D}} = 10 \text{ mA}$, $V_{\text{GS}} = 2.5 \text{ V}$		4	6	
		$I_{\text{D}} = 10 \text{ mA}$, $V_{\text{GS}} = 4.0 \text{ V}$		3	4	
Forward transfer admittance	$ Y_{\text{fs}} $	$I_{\text{D}} = 10 \text{ mA}$, $V_{\text{DS}} = 3 \text{ V}$	20	55		mS
Short-circuit input capacitance (Common source)	C_{iss}	$V_{\text{DS}} = 3 \text{ V}$, $V_{\text{GS}} = 0$, $f = 1 \text{ MHz}$		10		pF
Short-circuit output capacitance (Common source)	C_{oss}			13		pF
Reverse transfer capacitance (Common source)	C_{rss}			5		pF
Turn-on time *	t_{on}	$V_{\text{DD}} = 3 \text{ V}$, $V_{\text{GS}} = 0 \text{ V}$ to 3 V , $I_{\text{D}} = 10 \text{ mA}$		250		ns
Turn-off time *	t_{off}	$V_{\text{DD}} = 3 \text{ V}$, $V_{\text{GS}} = 3 \text{ V}$ to 0 V , $I_{\text{D}} = 10 \text{ mA}$		480		ns

■ Electrical Characteristics (continued) $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

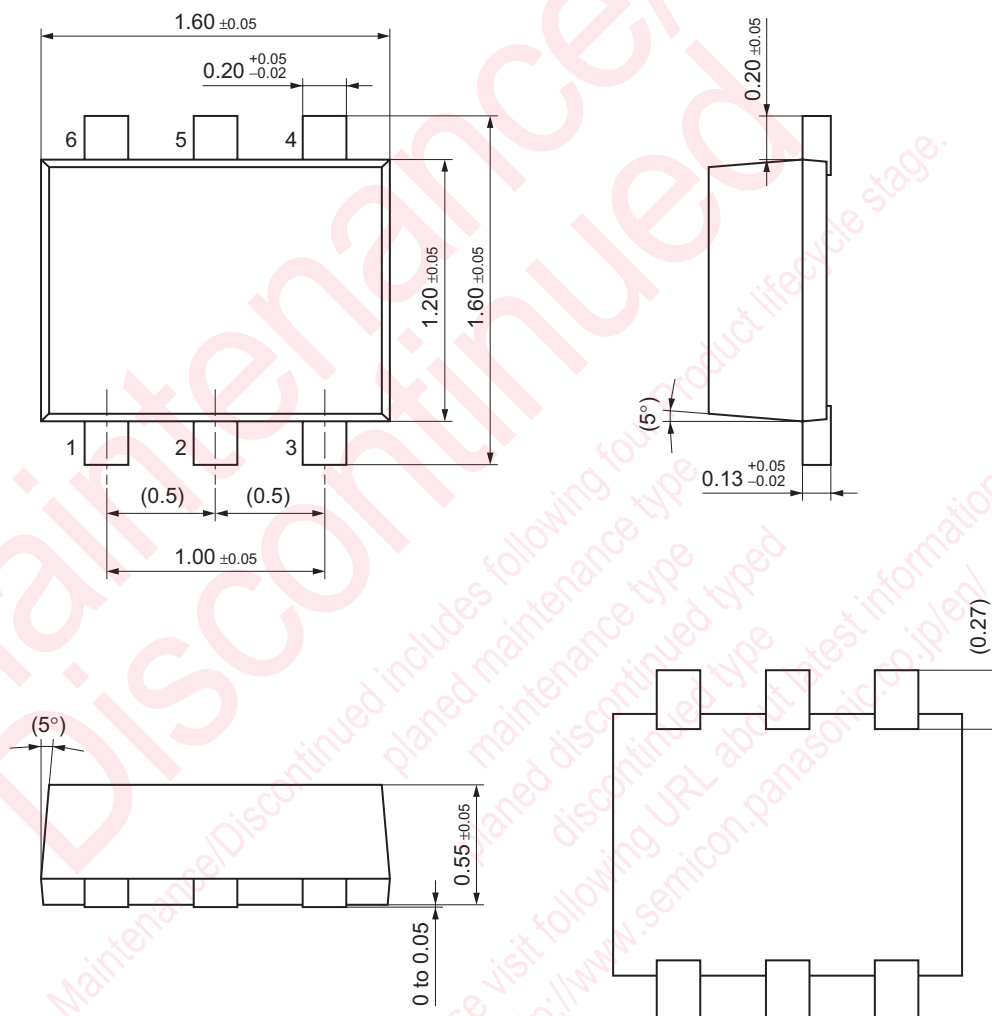
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. *: t_{on} , t_{off} measurement circuit



SSMini6-F2

Unit: mm



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